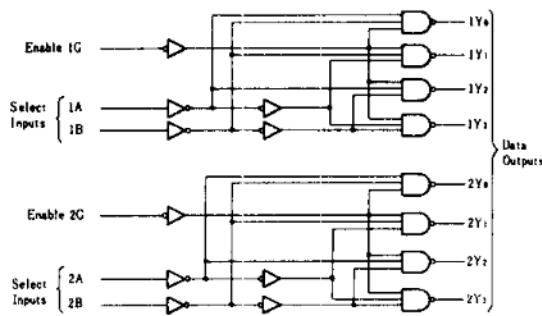


HD74LS139

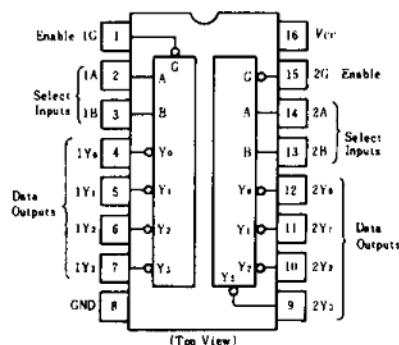
• Dual 2-line-to-4-line Decoders/Demultiplexers

The HD74LS139 comprises two individual two-line-to-four-line decoder in a single package. The active-low enable input can be used as a data line in demultiplexing applications.

■ BLOCK DIAGRAM



■ PIN ARRANGEMENT



■ FUNCTION TABLE

Enable	Inputs			Outputs			
	G	B	A	Y ₀	Y ₁	Y ₂	Y ₃
H		X	X	H	H	H	H
L	L	L	L	L	H	H	H
L	L	L	H	H	L	H	H
L	H	L	L	H	H	L	H
L	H	H	H	H	H	H	L

H; high level, L; low level, X; irrelevant

■ ELECTRICAL CHARACTERISTICS ($T_a = -20 \sim +75^\circ C$)

Item	Symbol	Test Conditions		min	typ*	max	Unit
Input voltage	V_{IH}			2.0	—	—	V
	V_{IL}			—	—	0.8	V
Output voltage	V_{OH}	$V_{CC}=4.75V, V_{IH}=2V, V_{IL}=0.8V, I_{OH}=-400\mu A$		2.7	—	—	V
	V_{OL}	$V_{CC}=4.75V, V_{IH}=2V, V_{IL}=0.8V$	$I_{OL}=4mA$	—	—	0.4	V
			$I_{OL}=8mA$	—	—	0.5	
Input current	I_I	$V_{CC}=5.25V, V_I=7V$		—	—	0.1	mA
	I_{IH}	$V_{CC}=5.25V, V_I=2.7V$		—	—	20	μA
	I_{IL}	$V_{CC}=5.25V, V_I=0.4V$		—	—	-0.4	mA
Short-circuit output current	I_{OS}	$V_{CC}=5.25V$		-5	—	-42	mA
Supply current	I_{CC}	$V_{CC}=5.25V, \text{ Outputs enabled and open}$		—	6.8	11	mA
Input clamp voltage	V_{IK}	$V_{CC}=4.75V, I_{IN}=-18mA$		—	—	-1.5	V

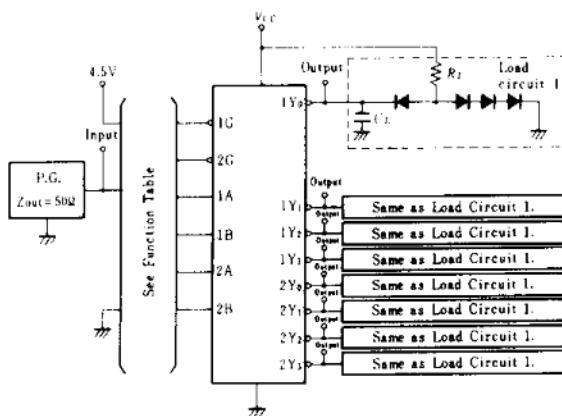
* $V_{CC}=5V, T_a=25^\circ C$

■ SWITCHING CHARACTERISTICS ($V_{CC}=5V, T_a=25^\circ C$)

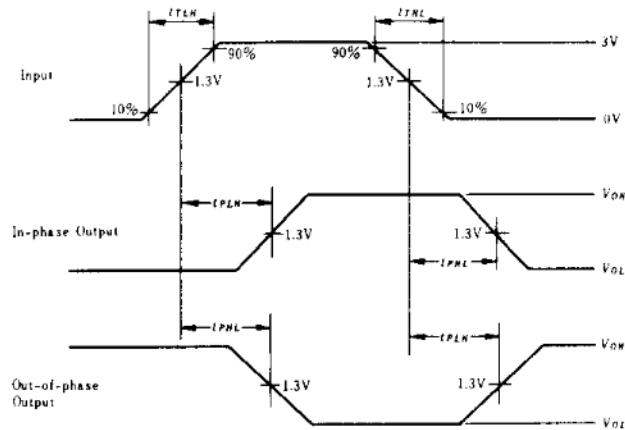
Item	Symbol	Inputs	Outputs	Levels of delay	Test Conditions	min	typ	max	Unit	
Propagation delay time	t_{PLH}	Binary	1Y ₀ —1Y ₃	2	$C_L=15pF$ $R_L=2k\Omega$	—	13	20	ns	
	t_{PHL}	Select				—	22	33	ns	
	t_{PLH}	1A, 1B	2Y ₀ —2Y ₃	3		—	18	29	ns	
	t_{PHL}	2A, 2B	—			25	38	ns		
	t_{PLH}	Enable	1Y ₀ —1Y ₃	2		—	16	24	ns	
	t_{PHL}	1G, 2G	2Y ₀ —2Y ₃			—	21	32	ns	

■ TESTING METHOD

1) Test Circuit

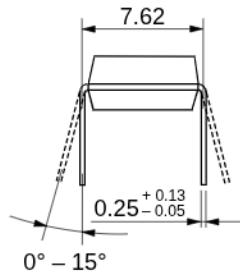
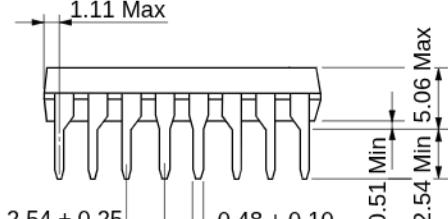
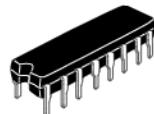
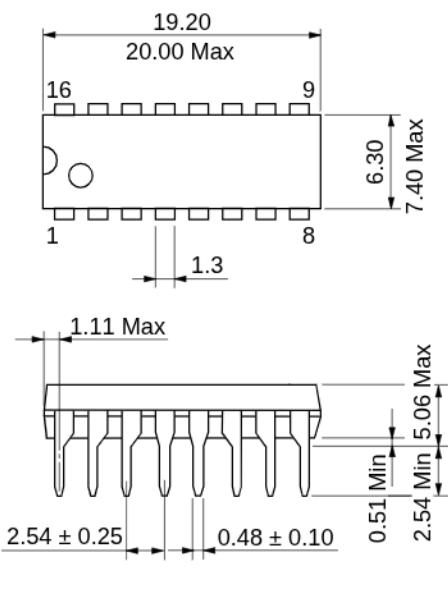


Waveform

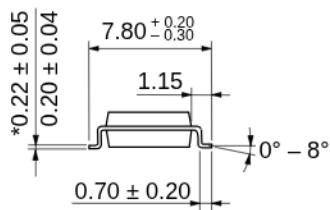
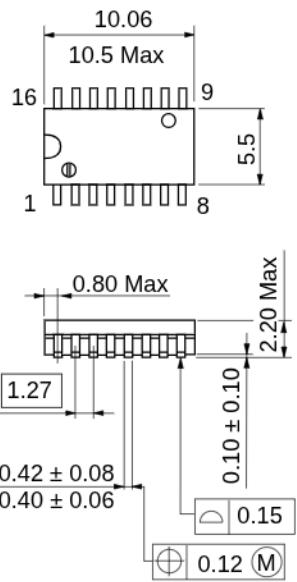


- Notes)
1. Input pulse; $t_{TLH} \leq 15\text{ns}$, $t_{TFL} \leq 6\text{ns}$, $PRR = 1\text{MHz}$, duty cycle=50%
 2. C_L includes probe and jig capacitance.
 3. All diodes are 1S2074 (H).

Unit: mm

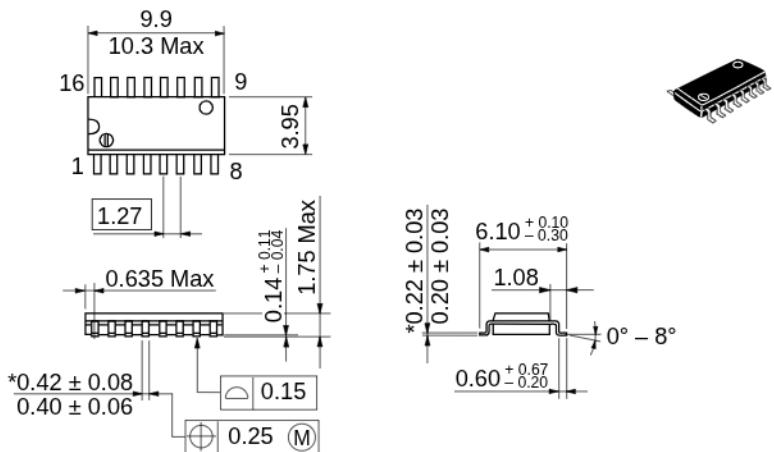


Hitachi Code	DP-16
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	1.07 g



*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.24 g



*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.15 g

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